

DTQ611D10SJ www.din-tek.jp

Dual N-Channel 100 V (D-S) Super Junction MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ.)	I _D (A)ª	Q _g (Typ.)			
100	9.6 at V _{GS} = 10 V	45	17.6nC			
100	11.9 at V _{GS} = 4.5 V	-10	17.0110			

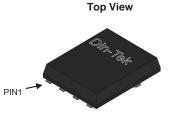
DFN5X6-8L Pin Configuration

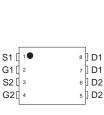
FEATURES

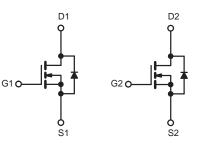
- DT-SJ Power MOSFET
- 100 % R_g and UIS Tested
- 100% Avalanche Test
- High Speed Power Switching

APPLICATIONS

- DC/DC in Telecoms and Inductrial
- Synchronous Rectification in SMPS
- · Hard Switching and High Speed Circuit







N1-Channel MOSFET

N2-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	100	V		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current (T _{.1} = 150 °C) ^a	T _C = 25 °C	1-	45		
	T _C = 100 °C	I _D	29	А	
Pulsed Drain Current ^b	I _{DM}	176			
Single Avalanche Energy	E _{AS}	130	mJ		
Maximum Power Dissipation ^c	T _C = 25 °C	- P _D	43	W	
	T _C = 100 °C	ГD	17		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to + 150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) ^d	R _{thJA}	50	°C/W		
Junction-to-Case (Drain)	R _{thJC}	2.9	°C/VV		

Notes

a. Calculated continuous current based on maximum allowablejunction temperature.

- b. Repetitive rating; pulse width limited by max. junction temperature.
- c. Pd is based on max. junction temperature, using junction-case thermal resistance.
- d. The value of ReuA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.



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SPECIFICATIONS (T _C = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I _D = 250 µA	100	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.2	-	2.5	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 100 V, V_{GS} = 0 V$	-	-	1	- μΑ	
Zero Gale Voltage Drain Current	IDSS	$V_{DS}{=}80$ V, $V_{GS}{=}0$ V, $T_{J}{=}125$ °C	-	-	100		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	45	-	-	А	
Drain-Source On-State Resistance ^a	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	9.6	11.6	mΩ	
	R _{DS(on)}	V_{GS} = 4.5 V, I_{D} = 15 A	-	11.9	14.9		
Forward Transconductance a	g fs	$V_{DS} = 5 V, I_{D} = 20 A$	-	31	-	S	
Dynamic ^b							
Input Capacitance	C _{iss}		-	1072	-	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 50 V, f = 1 MHz$	-	491	-		
Reverse Transfer Capacitance	C _{rss}		-	12	-		
Total Gate Charge ^c	Qg		-	17.6	-		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	3.5	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	3.6	-		
Gate Resistance	R _g	f = 1 MHz	-	1.2	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	4.1	-		
Rise Time ^c	tr	$V_{DD} = 50 \text{ V}, I_D = 20 \text{ A},$	-	3.6	-		
Turn-Off Delay Time ^c	t _{d(off)}	$R_g = 3\Omega, V_{GS} = 10 V$	-	16	-	ns	
Fall Time ^c	t _f		-	9.1	-		
Drain-Source Body Diode Ratings and	Characterist	ics ^b (T _C = 25 °C)					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C	-	-	45	А	
Pulsed Current	I _{SM}		-	-	176	А	
Forward Voltage ^a	V _{SD}	$I_{F} = 2 A, V_{GS} = 0 V$	-	0.7	1.2	V	
Reverse Recovery Time	t _{rr}		-	43	-	ns	
Reverse Recovery Charge	Q _{rr}	I _F = 20 A, di/dt = 100 A/μs	-	59	-	nC	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those in dicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended pe riods may affect device reliability.



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TYPICAL CHARAC TERISTICS (25 °C, unless otherwise noted)

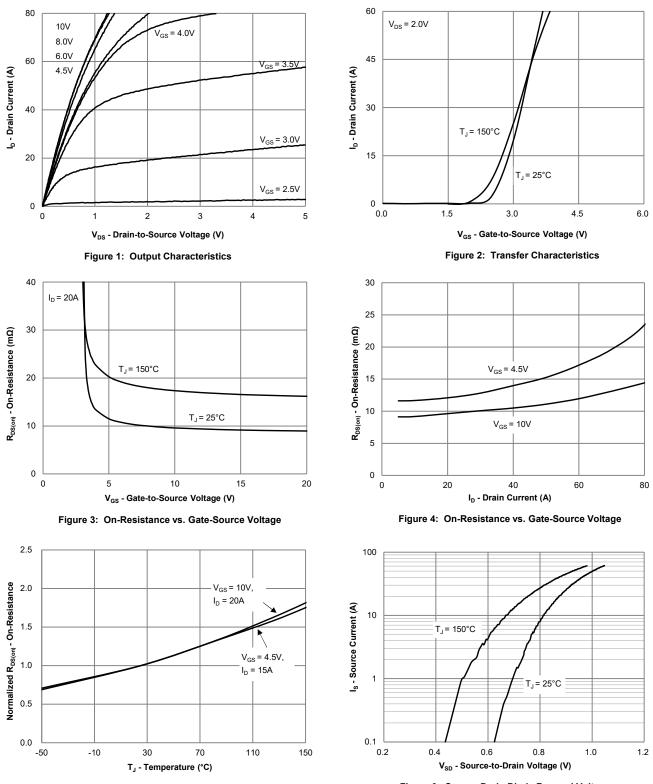


Figure 5: On-Resistance vs. Junction Temperature

Figure 6: Source-Drain Diode Forward Voltage



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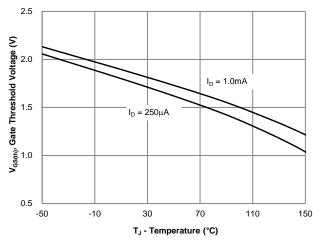
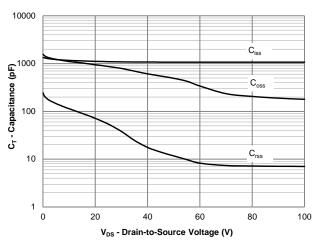
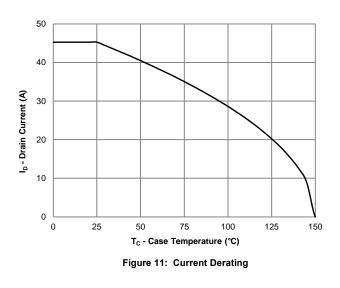


Figure 7: Gate Threshold Variation vs. Junction Temperature







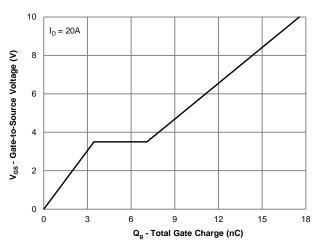
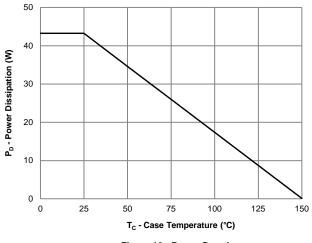
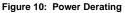
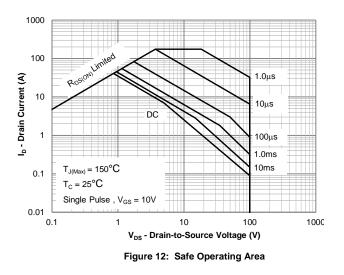


Figure 8: Gate Charge Characteristics

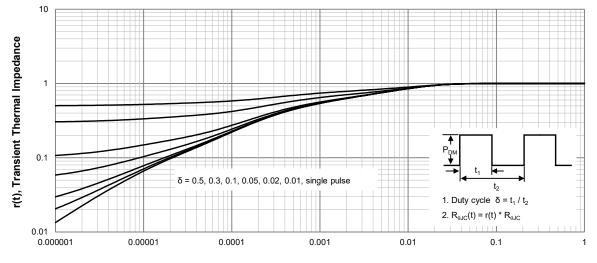








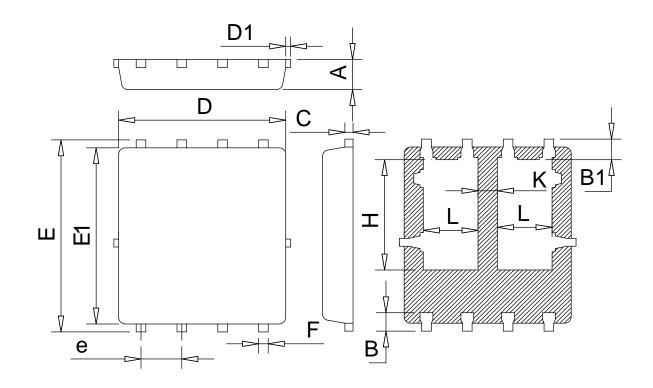
TYPICAL CHARAC TERISTICS (25 °C, unless otherwise noted)



Pulse Width (s) Figure 13: Normalized Maximum Transient Thermal Impedance



DFN5X6-8L-D PACKAGE OUTLINE



COMMON DIMENSIONS UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
A	0.85	0.95	1.05
В	0.46	0.58	0.73
B1	0.52	0.65	0.78
С	0.18	0.254	0.32
D	4.70	5.20	5.50
D1	-	-	0.18
E	5.75	6.05	6.35
E1	5.35	5.65	5.85
е	1.15	1.27	1.50
F	0.15	0.30	0.50
Н	3.15	3.47	3.80
L	1.35	1.70	2.10
K	0.35	0.60	1.00



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